MOSFET - SiC Power, Single N-Channel

1200 V, 65 mΩ, 49 A

KXMW120R80T3

Features

- Typ. $R_{DS(on)} = 65 \text{ m}\Omega$
- Ultra Low Gate Charge $(Q_{G(tot)} = 46 \text{ nC})$
- Capacitance (Coss = 83 pF)
- 100% UIL Tested

Typical Applications

- UPS
- DC/DC Converter
- Boost Inverter

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Parame	Symbol	Value	Unit		
Drain-to-Source Voltage	V _{DSS}	1200	V		
Gate-to-Source Voltage			V _{GS}	-7/23	V
Recommended turn on Gate-to- Source Voltage T _C < 175°C			V _{GS, on}	15-18	V
Recommended turn off Ga Source Voltage	10 4 173 0	V _{GS, off}	0	V	
Continuous Drain	Steady State	T _C = 25°C	· ID	49	А
Current ReJC		T _C = 100°C		35	А
Power Dissipation Rejc	Steady State	T _C = 25°C	P _D	251	w
Power Dissipation (%)C		T _C = 150°C		42	**
Pulsed Drain Current (Note 2) T _A = 25°C			I _{DM}	109	А
Operating Junction and S Range	T _J , T _{stg}	-55 to +175	°C		
Source Current (Body Dio	Is	49	Α		

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS

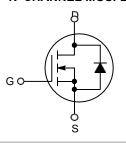
Parameter	Symbol	Value	Unit
Junction-to-Case (Note 1)	R _{0JC}	0.6	°C/W
Junction-to-Ambient (Note 1)	$R_{\theta JA}$	33.62	°C/W

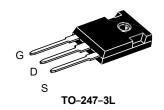
- 1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.
- 2. Repetitive rating, limited by max junction temperature.



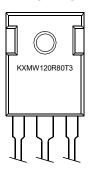
V _{(BR)DSS}	R _{DS(on)} MAX	I _D MAX	
1200 V	65mΩ	49 A	

N-CHANNEL MOSFET





MARKING DIAGRAM



Publication Order Number: **KXMW120R80T3**

KXMW120R80T3

Static Electrical Characteristics

Parameter Symbol Test Conditions		Min	Тур	Max	Unit		
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} =0 V, I _D = 100 uA		1200	1480	V	
Zoro Coto Voltago Proin Current		V _{GS} = 0 V, V _{DS} = 1200 V, T _J = 25 °C		0.5	100		
Zero Gate Voltage Drain Current	IDSS	V _{GS} = 0 V, V _{DS} = 1200 V, T _J = 175 °C		3	100	μA	
Coto Source Leakage Current	1	V _{GS} = -10V, V _{DS} = 0V		-0.3	-100	- ^	
Gate-Source Leakage Current	I _{GSS}	V_{GS} = 25V, V_{DS} = 0V		4	100	nA	
Transconductance	g fs	V _{DS} = 20V, I _D = 15 A, T _J = 25 °C		7.89		S	
Transconductance		V _{DS} = 20 V, I _D = 15 A, T _J = 175 °C		7.75		3	
Drain-Source On Resistance	D	V _{GS} = 20V, I _D = 15 A, T _J = 25 °C		65		mΩ	
Dialii-Source Off Resistance	$R_{DS(on)}$	V _{GS} = 20 V, I _D = 15 A, T _J = 175 °C		103			
Out The shall Walks		$V_{GS} = V_{DS} = 20 \text{ V}, I_D = 5 \text{ mA}, T_J = 25 ^{\circ}\text{C}$		2.9		.,,	
Gate Threshold Voltage	V _{GS(th)}	V_{GS} = V_{DS} = 20 V, I_D = 5 mA, T_J = 175 °C		2		V	

Dynamic Electrical Characteristics

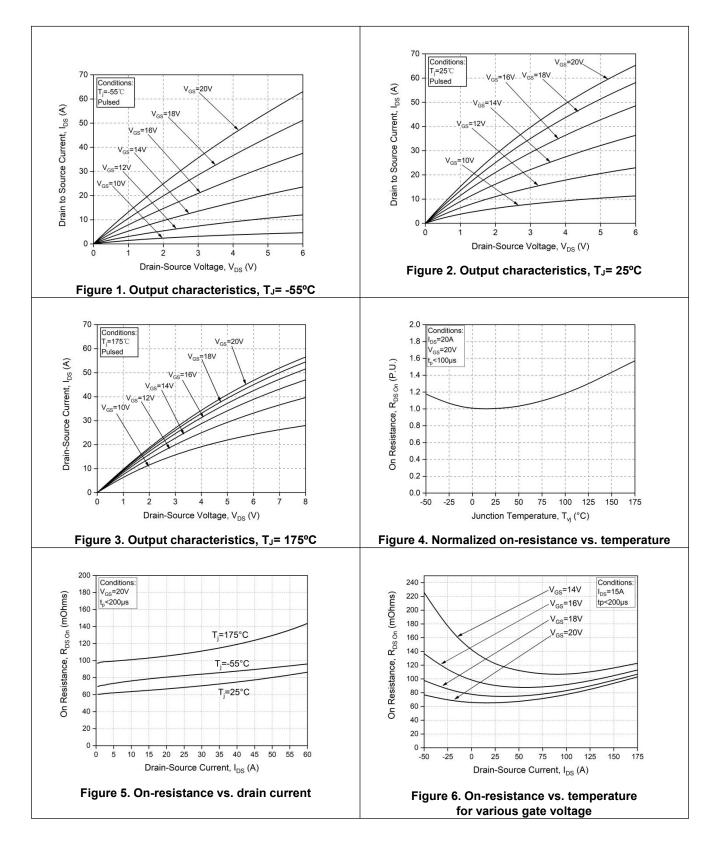
Parameter	Symbol	Test Conditions	Тур	Unit
Input Capacitance	C _{ISS}		1083	
Output Capacitance	Coss	V _{GS} = 0 V, V _{DS} = 1000 V,	83	pF
Reverse TransferCapacitance	C _{RSS}	f = 1 MHz, V _{AC} = 25 mV	3	
C _{OSS} Stored Energy	Eoss		83	μJ
Turn-On Switching Loss	E _{ON}	$V_{GS} = -4/20 \text{ V}, V_{DS} = 800 \text{ V},$ $I_D = 20\text{A}, R_G = 2 \Omega, Inductive Load}$	376	
g		T _J = 25 °C T _J = 175 °C	380	μJ
	_	$V_{GS} = -4/20 \text{ V}, V_{DS} = 800 \text{ V},$ $I_D = 20A, R_G = 2 \Omega, Inductive Load$	408	
Turn-Off SwitchingLoss	E _{OFF}	T _J = 25 °C T _J = 175 °C	441	
Total Gate Charge	Q _{G(tot)}		46	nC
Gate-Source Charge	Q _{GS}	VGS = -4/20 V, V _{DS} = 800 V, I _D = 15 A	15	
Gate-Drain Charge	Q_{GD}		15	
Gate Resistance	R _G	f = 1 MHz, V _{AC} = 25 mV	3.4	Ω
Turn-On Delay Time	t _{d(on)}		12	
Rise Time	t _r	V _{GS} = -4/20 V, V _{DS} = 800 V,	8	
Turn-Off Delay Time	t _{d(off)}	I _D = 15A, R _G = 2 Ω,T _J = 175 °C Inductive Load	18	ns
Fall Time	t _f		46	

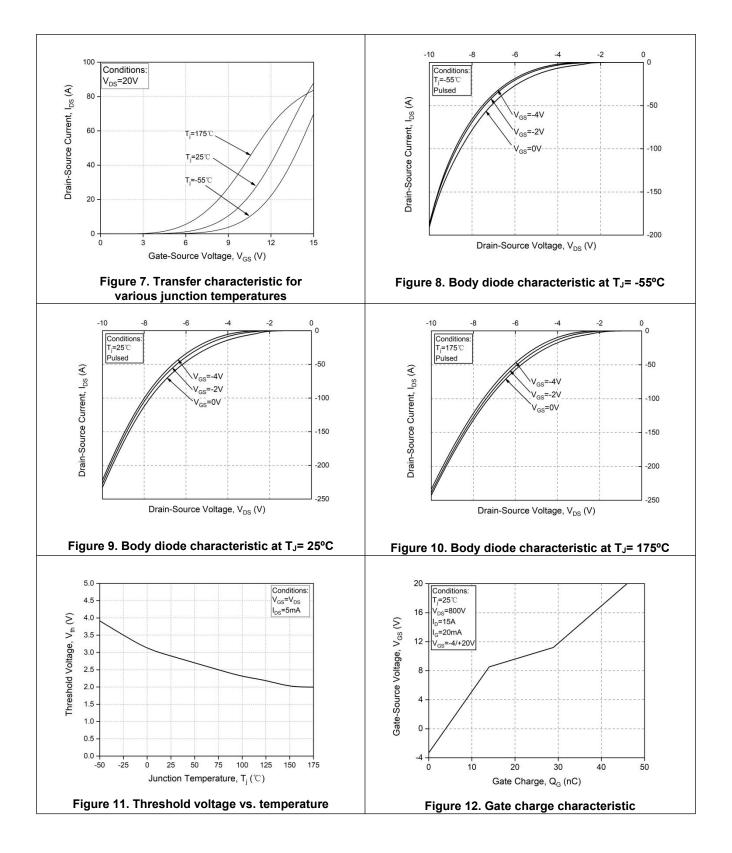
KXMW120R80T3

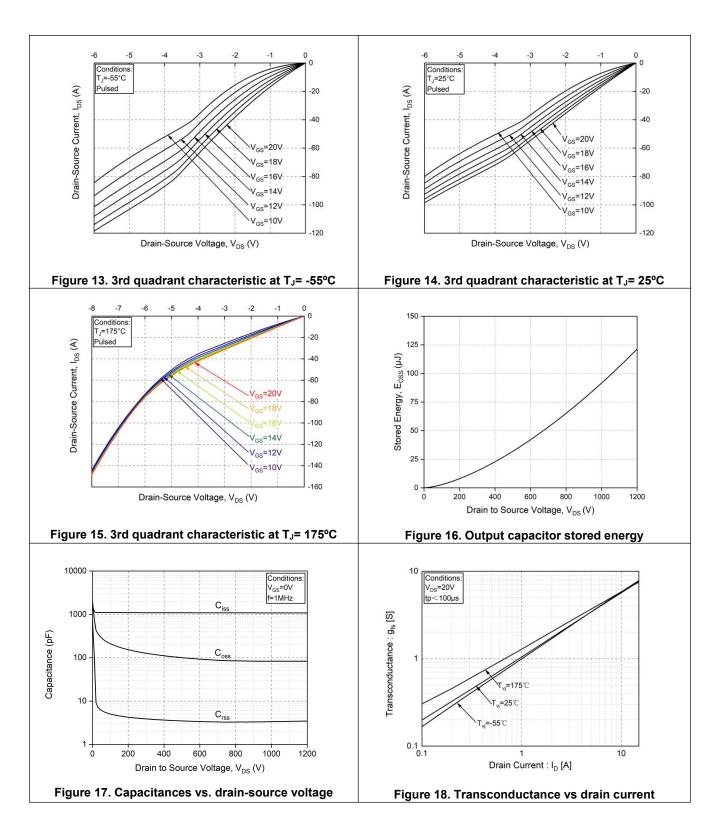
Reverse Diode Characteristic

Parameter	Symbol	Test Conditions	Тур	Unit	
Continuous Drain-to-Source Diode Forward Current	I _{SD}	V _{GS} = 0 V, T _J = 25 °C	49	А	
		V _{GS} = 0 V, I _{SD} = 15 A, T _J = -55 °C	5.1		
Forward Diode Voltage	V _{SD}	V _{GS} = 0 V, I _{SD} = 15 A, T _J = 25 °C	4.2	V	
		V _{GS} = 0 V, I _{SD} = 15 A, T _J = 175 °C	4.2		
Pulsed Drain-to-Source Diode For- ward Current (Note 2)	I _{SDM}	T _J = 25 °C	508 512	А	
Reverse Recovery Time	t _{RR}		15	ns	
Reverse Recovery Charge	Q _{RR}	V _{GS} =-4V, I _{SD} = 20A, V _{DS} = 800 V,	77	nC	
Peak Reverse Recovery Current	I _{RRM}	dls/dt = 1000 A/μs, T _J = 25 °C Qfr includes also QC	9.5	Α	
Reverse Recovery Energy	E _{RR}		58	μJ	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.







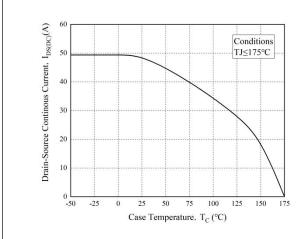


Figure 19. Continuous drain current derating vs. case temperature

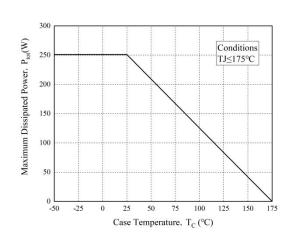


Figure 20. Maximum power dissipation derating vs. case temperature

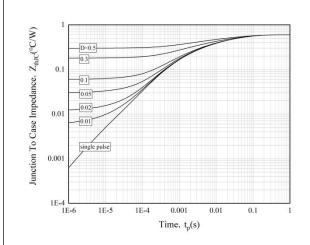


Figure 21. Transient thermal impedance (junction - case)

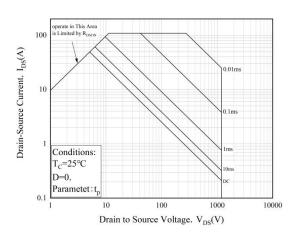


Figure 22. Safe operating area

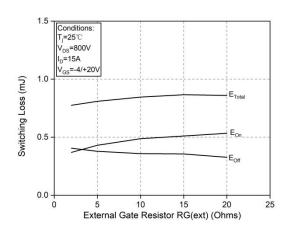


Figure 23. Clamped inductive switching energy vs. R_G(ext)

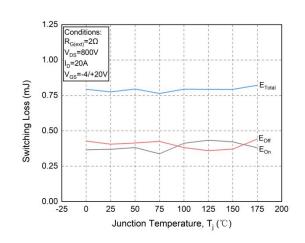
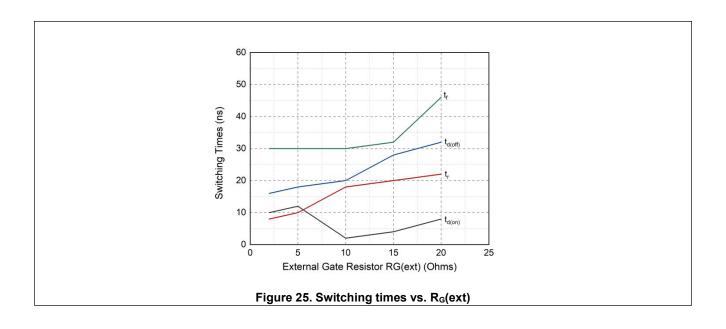
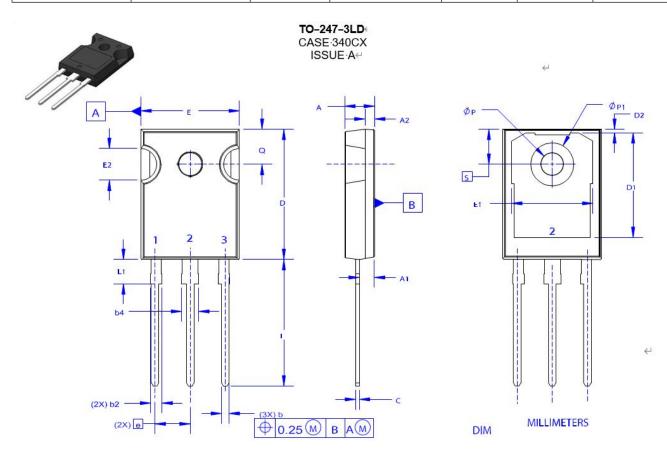


Figure 24. Clamped inductive switching energy vs. temperature



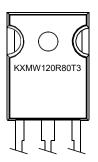
PACKAGE MARKING AND ORDERING INFORMATION

Part N	umber	Top Marking	Package	Packing Method	Reel Size	Tape Width	Quantity
KXMW1	20R80T3	KXMW120R80T3	TO-247 Long Lead	Tube	N/A	N/A	30 Units



NOTES: UNLESS OTHERWISE SPECIFIED.

- A. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
- B. ALL DIMENSIONS ARE IN MILLIMETERS.
- C. DRAWING CONFORMS TO ASME Y14.5 2009.
- D. DIMENSION A1 TO BE MEASURED IN THE REGION DEFINED BY L1.
- E. LEAD FINISH IS UNCONTROLLED IN THE REGION DEFINED BY L1.



DIM	MIL	LIMETER	S	
DIM	MIN	NOM	MAX	
Α	4.58	4.70	4.82	
A1	2.20	2.40	2.60	
A2	1.40	1.50	1.60	
D	20.32	20.57	20.82	
E	15.37	15.62	15.87	
E2	4.96	5.08	5.20	
е	~	5.56	~	
L	19.75	20.00	20.25	
L1	3.69	3.81	3.93	
ØР	3.51	3.58	3.65	
Q	5.34	5.46	5.58	
S	5.34	5.46	5.58	
b	1.17	1.26	1.35	
b2	1.53	1.65	1.77	
b4	2.42	2.54	2.66	
С	0.51	0.61	0.71	
D1	13.08	~	~	
D2	0.51	0.93	1.35	
E1	12.81	: ~	~	
ØP1	ØP1 6.60		7.00	